UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/519,152	08/10/2005	Masatomo Shibata	23165	5477
23389 7590 03/24/2010 SCULLY SCOTT MURPHY & PRESSER, PC 400 GARDEN CITY PLAZA SUITE 300 GARDEN CITY, NY 11530			EXAMINER	
			TRAN, TRANG Q	
			ART UNIT	PAPER NUMBER
			2811	
			MAIL DATE	DELIVERY MODE
			03/24/2010	PAPER

Please find below and/or attached an Office communication concerning this application or proceeding.

The time period for reply, if any, is set in the attached communication.

	Application No.	Applicant(s)
	10/519,152	SHIBATA ET AL.
Office Action Summary	Examiner	Art Unit
	TRANG Q. TRAN	2811
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with the c	correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D. - Extensions of time may be available under the provisions of 37 CFR 1. after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period. - Failure to reply within the set or extended period for reply will, by statut Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	DATE OF THIS COMMUNICATION .136(a). In no event, however, may a reply be tird will apply and will expire SIX (6) MONTHS from te, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. D (35 U.S.C. § 133).
Status		
Responsive to communication(s) filed on 15 c This action is FINAL . 2b) ☑ This 3) ☐ Since this application is in condition for allowed closed in accordance with the practice under	is action is non-final. ance except for formal matters, pro	
Disposition of Claims		
4) Claim(s) 1-17 is/are pending in the application 4a) Of the above claim(s) 12,14 and 16 is/are 5) Claim(s) is/are allowed. 6) Claim(s) 1-11,13,15 and 17 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/o Application Papers 9) The specification is objected to by the Examin 10) The drawing(s) filed on 12/27/04 is/are: a)	withdrawn from consideration. or election requirement. er.	ne Examiner.
Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	e drawing(s) be held in abeyance. Section is required if the drawing(s) is ob	e 37 CFR 1.85(a). jected to. See 37 CFR 1.121(d).
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority document application from the International Bureat* * See the attached detailed Office action for a list.	nts have been received. nts have been received in Applicationity documents have been received au (PCT Rule 17.2(a)).	on No ed in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail D: 5) Notice of Informal F 6) Other:	ate

DETAILED ACTION

Claim Rejections - 35 USC § 112

The following is a quotation of the second paragraph of 35 U.S.C. 112:

The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.

Claims 1-4 are failing to particularly point out and distinctly define the metes and bounds of the subject matter because it is unclear what the preamble of the claims is.

Claims 5-11, 13, 15 and 17 are rejected because they depend on rejected claims 1-4.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

Claims 1-11, 13, 15 and 17 are rejected under 35 U.S.C. 102(e) as being anticipated by Ohmi et al. (US 6,597,039)

Re. claim 1, Fig. 8 of Ohmi discloses a porous substrate (3), comprising a plurality of porous layers (22/23) thereon, wherein the average opening diameter of pores in a porous layer (22) of said plurality of porous layers positioned in an outermost surface is smaller than the average diameter of pores in a porous layer (23) of said plurality of porous layers positioned on a substrate (2) side relative to said porous layer

positioned in said outermost surface (as seen in Fig. 8 and Col. 13, lines 52-65).

Re. claims 2-4, Fig. 8 of Ohmi discloses a porous substrate (2'+3'), comprising two porous layers (2'+3') thereon, wherein the average opening diameter of pores in a first porous layer (3') of said two porous layers (2'+3') positioned in an outermost surface is smaller than the average diameter of pores in a second porous layer (2') positioned on a substrate (1) side relative to said first porous layer (3'); "more than 50% of said pores in said first porous layer penetrate from the surface of said first porous layer to the interface between said first and second porous layer" (see Note 1 below);

Ohmi does not teach the volume porosity of said first and second porous layer is 10%-90%.

It would have been obvious to one of the ordinary skill in the art at the time the invention was made to provide the volume porosity of said first and second porous layer is 10%-90% in Ohmi, in order to optimize the device performance.

It would have been obvious to choose certain measurement, since such a modification would have involved a mere change in the size of a component. A change in size is generally recognized as being within the level of ordinary skill in the art. See of the following: *In re Rose*, 220 F.2d 459, 105 USPQ 237 (CCPA 1955); *In re Rinehart*, 531 F.2d 1048, 189 USPQ 143 (CCPA 1976); *Gardner v. TEC Systems, Inc.*, 725 F.2d 1338, 220 USPQ 777 (Fed. Cir. 1984), *cert. denied*, 469 U.S. 830, 225 USPQ 232 (1984).

Re. claim 7, Ohmi discloses the porous substrate according to claim 3, wherein said second porous layer (23) comprises a semiconductor material (Col. 14, lines 20-25).

Re. claim 8, Ohmi discloses the porous substrate according to claim 3, wherein said second porous layer (23) comprises a group III nitride series compound semiconductor material (1-GaN).

Re. claims 10 and 11, Ohmi discloses the porous substrate according to claim 3, Ohmi does not teach wherein said average opening diameter of said porosity in said first porous layer is not more than 1 μ m and the film thickness of said first porous layer is not more than 1 μ m.

It would have been obvious to one of the ordinary skill in the art at the time the invention was made to provide said average opening diameter of said porosity in said first porous layer and the film thickness of said first porous layer is not more than 1 μ m in Ohmi, in order to optimize the device performance.

Furthermore, it has been held that where then general conditions of a claim are disclosed in the prior art, discovering the optimum or workable ranges involves only routine skill in the art. *In re Aller*, 105 USPQ 233.

Re. claim 13, Ohmi discloses a GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer (1) grown on a porous substrate (3)

Art Unit: 2811

defined claim 1.

Re. claim 15, Ohmi discloses a GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer (1) grown on a porous substrate (3) defined in claim 2.

Re. claim 17, Ohmi discloses a GaN series semiconductor layered substrate, comprising a GaN series semiconductor layer (1) grown on a porous substrate (3) defined in claim 4.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to TRANG Q. TRAN whose telephone number is (571)270-3259. The examiner can normally be reached on Mon - Thu (9am-5pm).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Lynne A. Gurley can be reached on 571-272-1670. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Application/Control Number: 10/519,152 Page 6

Art Unit: 2811

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

/T. Q. T./

Examiner, Art Unit 2811

/Cuong Q Nguyen/

Primary Examiner, Art Unit 2811